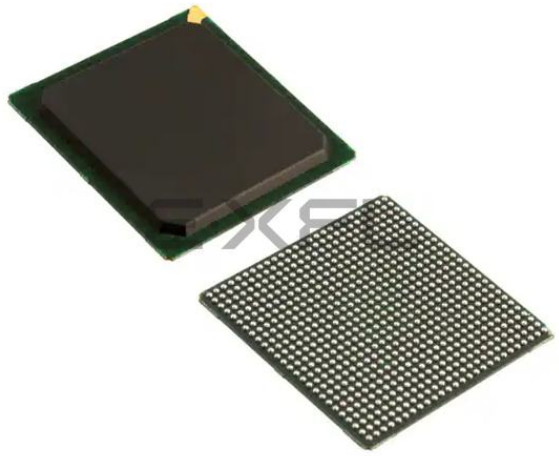

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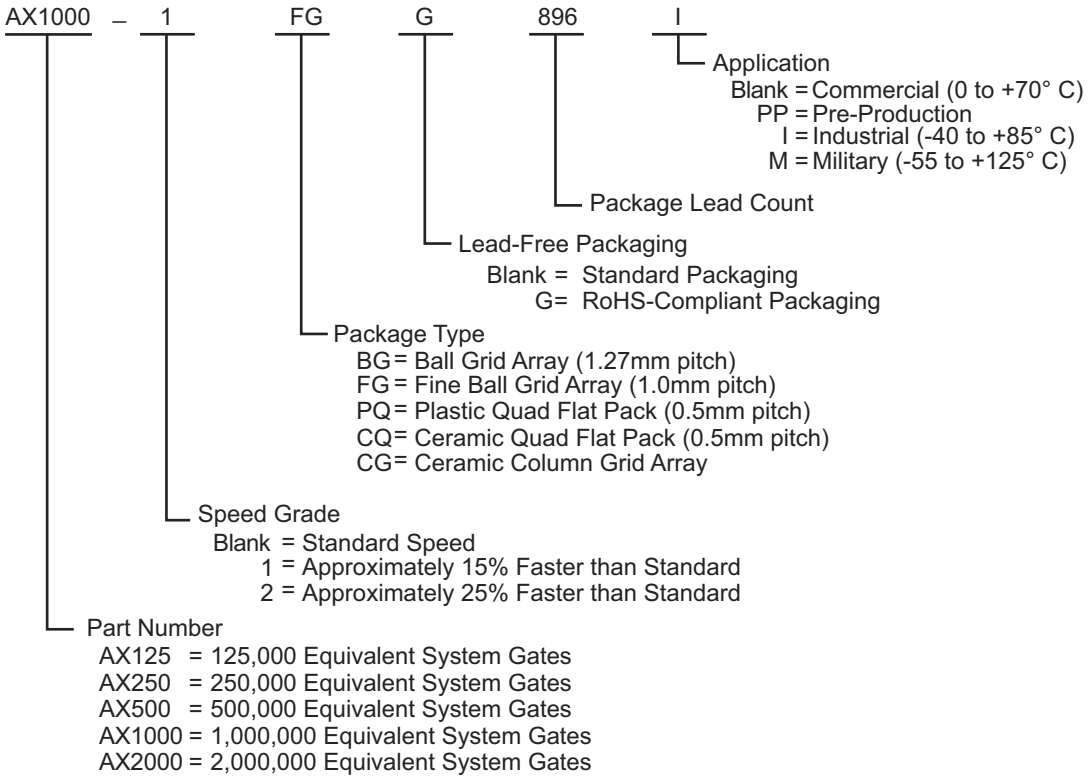
Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	18144
Number of Logic Elements/Cells	-
Total RAM Bits	165888
Number of I/O	418
Number of Gates	1000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 85°C (TA)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/ax1000-1fgg676i

Ordering Information



Device Resources

	User I/Os (Including Clock Buffers)				
Package	**AX125**	**AX250**	**AX500**	**AX1000**	**AX2000**
PQ208	–	115	115	–	–
CQ208	–	115	115	–	–
CQ256	–	–	–	–	136
FG256	138	138	–	–	–
FG324	168	–	–	–	–
CQ352	–	198	198	198	198
FG484	–	248	317	317	–
CG624	–	–	–	418	418
FG676	–	–	336	418	–
BG729	–	–	–	516	–
FG896	–	–	–	516	586
FG1152	–	–	–	–	684

Note: The FG256, FG324, and FG484 are footprint compatible with one another. The FG676, FG896, and FG1152 are also footprint compatible with one another.

Axcelerator Family Device Status

Axcelerator® Devices	Status
AX125	Production
AX250	Production
AX500	Production
AX1000	Production
AX2000	Production

Temperature Grade Offerings

Package	AX125	AX250	AX500	AX1000	AX2000
PQ208	–	C, I, M	C, I, M	–	–
CQ208	–	M	M	–	–
CQ256	–	–	–	–	M
FG256	C, I	C, I, M	–	–	–
FG324	C, I	–	–	–	–
CQ352	–	M	M	M	M
FG484	–	C, I, M	C, I, M	C, I, M	–
CG624	–	–	–	M	M
FG676	–	–	C, I, M	C, I, M	–
BG729	–	–	–	C, I, M	–
FG896	–	–	–	C, I, M	C, I, M
FG1152	–	–	–	–	C, I, M

C = Commercial

I = Industrial

M = Military

Speed Grade and Temperature Grade Matrix

Temperature Grade	Std	–1	–2
C	✓	✓	✓
I	✓	✓	✓
M	✓	✓	–

C = Commercial

I = Industrial

M = Military

Figure 1-2 • **Axcelerator Family Interconnect Elements**

Logic Modules

Microsemi's Axcelerator family provides two types of logic modules: the register cell (R-cell) and the combinatorial cell (C-cell). The Axcelerator device can implement more than 4,000 combinatorial functions of up to five inputs (Figure 1-3).

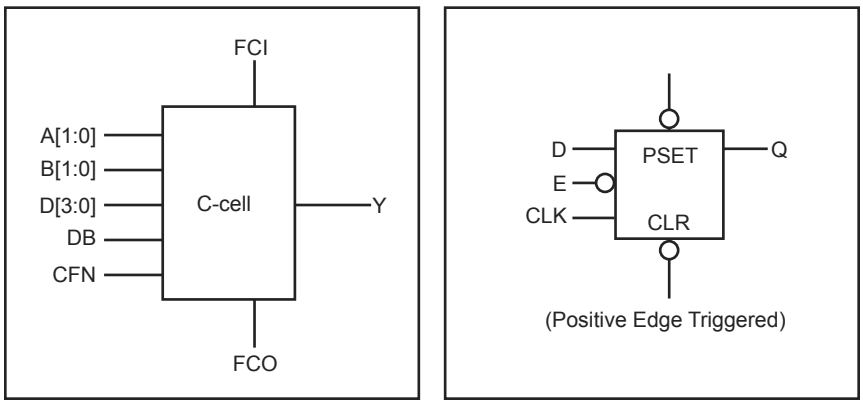


Figure 1-3 • **AX C-Cell and R-Cell**

The R-cell contains a flip-flop featuring asynchronous clear, asynchronous preset, and active-low enable control signals (Figure 1-3). The R-cell registers feature programmable clock polarity selectable on a register-by-register basis. This provides additional flexibility (e.g., easy mapping of dual-data-rate functions into the FPGA) while conserving valuable clock resources. The clock source for the R-cell can be chosen from the hardwired clocks, routed clocks, or internal logic.

2 – Detailed Specifications

Operating Conditions

Table 2-1 lists the absolute maximum ratings of Axcelerator devices. Stresses beyond the ratings may cause permanent damage to the device. Exposure to Absolute Maximum rated conditions for extended periods may affect device reliability. Devices should not be operated outside the recommendations in Table 2-2.

Table 2-1 • **Absolute Maximum Ratings**

Symbol	Parameter	Limits	Units
VCCA	DC Core Supply Voltage	–0.3 to 1.7	V
VCCI	DC I/O Supply Voltage	–0.3 to 3.75	V
VREF	DC I/O Reference Voltage	–0.3 to 3.75	V
VI	Input Voltage	–0.5 to 4.1	V
VO	Output Voltage	–0.5 to 3.75	V
TSTG	Storage Temperature	–60 to +150	°C
VCCDA*	Supply Voltage for Differential I/Os	–0.3 to 3.75	V

*Note: * Should be the maximum of all VCCI.*

Table 2-2 • **Recommended Operating Conditions**

Parameter Range	Commercial	Industrial	Military	Units
Ambient Temperature (T_A)[1]	0 to +70	–40 to +85	–55 to +125	°C
1.5 V Core Supply Voltage	1.425 to 1.575	1.425 to 1.575	1.425 to 1.575	V
1.5 V I/O Supply Voltage	1.425 to 1.575	1.425 to 1.575	1.425 to 1.575	V
1.8 V I/O Supply Voltage	1.71 to 1.89	1.71 to 1.89	1.71 to 1.89	V
2.5 V I/O Supply Voltage	2.375 to 2.625	2.375 to 2.625	2.375 to 2.625	V
3.3 V I/O Supply Voltage	3.0 to 3.6	3.0 to 3.6	3.0 to 3.6	V
VCCDA Supply Voltage	3.0 to 3.6	3.0 to 3.6	3.0 to 3.6	V
VPUMP Supply Voltage	3.0 to 3.6	3.0 to 3.6	3.0 to 3.6	V

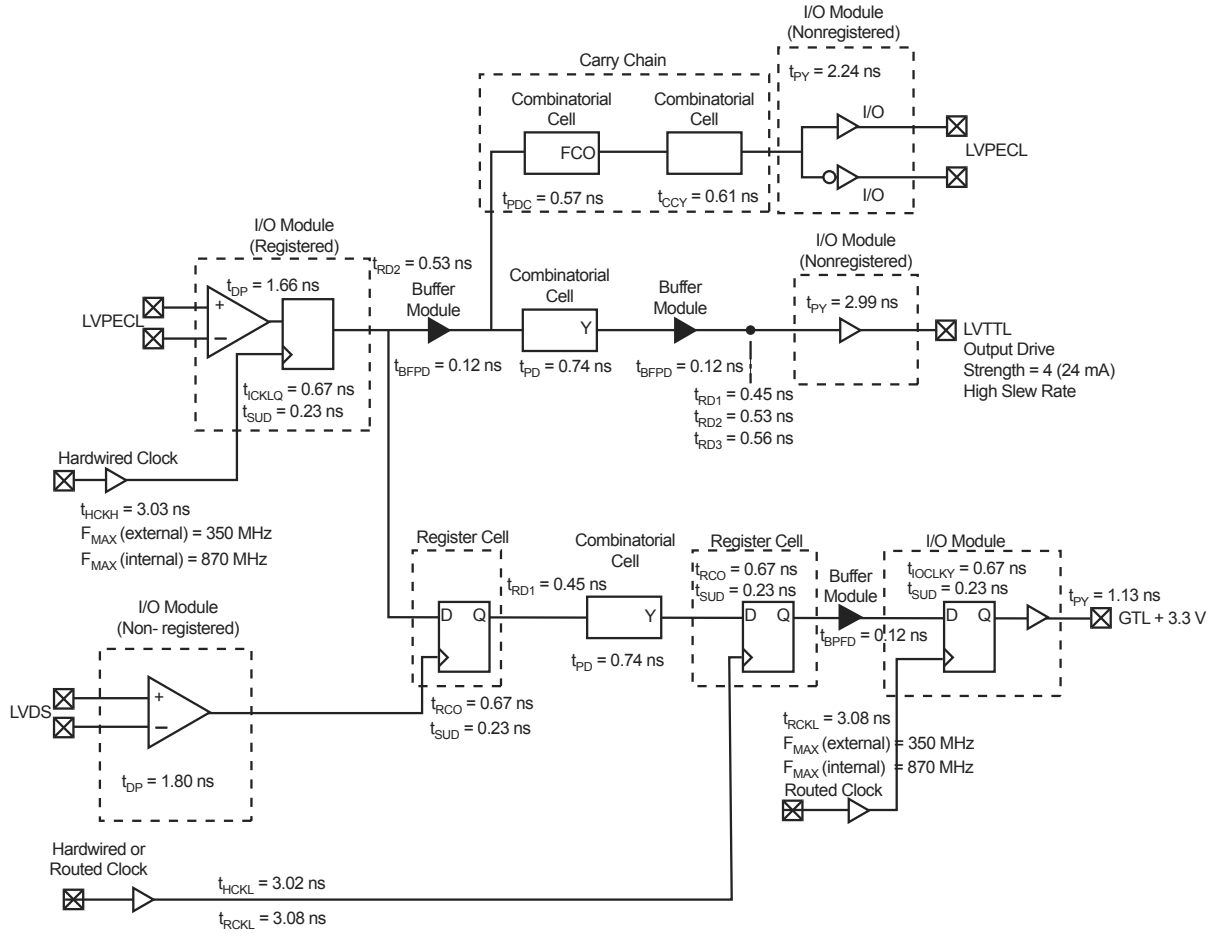
Notes:

1. *Ambient temperature (T_A) is used for commercial and industrial grades; case temperature (T_C) is used for military grades.*
2. *T_J max = 125°C*

Power-Up/Down Sequence

All Axcelerator I/Os are tristated during power-up until normal device operating conditions are reached, when I/Os enter user mode. VCCDA should be powered up before (or coincidentally with) VCCA and VCCI to ensure the behavior of user I/Os at system start-up. Conversely, VCCDA should be powered down after (or coincidentally with) VCCA and VCCI. Note that VCCI and VCCA can be powered up in any sequence with respect to each other, provided the requirement with respect to VCCDA is satisfied.

Timing Model



Note: Worst case timing data for the AX1000, –2 speed grade

Figure 2-1 • **Worst Case Timing Data**

Hardwired Clock – Using LVTTL 24 mA High Slew Clock I/O

External Setup

$= (t_{DP} + t_{RD2} + t_{SUD}) – t_{HCKL}$

$= (1.72 + 0.53 + 0.23) – 3.02 = –0.54$ ns

Clock-to-Out (Pad-to-Pad)

$= t_{HCKL} + t_{RCO} + t_{RD1} + t_{PY}$

$= 3.02 + 0.67 + 0.45 + 2.99 = 7.13$ ns

Routed Clock – Using LVTTL 24 mA High Slew Clock I/O

External Setup

$= (t_{DP} + t_{RD2} + t_{SUD}) – t_{RCKH}$

$= (1.72 + 0.53 + 0.23) – 3.13 = –0.65$ ns

Clock-to-Out (Pad-to-Pad)

$= t_{RCKH} + t_{RCO} + t_{RD1} + t_{PY}$

$= 3.13 + 0.67 + 0.45 + 3.03 = 7.24$ ns

***Table 2-22* • 3.3 V LVTTL I/O Module**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C (continued)

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
LVTTL Output Drive Strength =3 (16 mA) / High Slew Rate								
t_{DP}	Input Buffer		1.68		1.92		2.26	ns
t_{PY}	Output Buffer		3.12		3.56		4.18	ns
t_{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		3.54		4.04		4.75	ns
t_{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		2.78		3.17		3.72	ns
t_{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		1.91		1.93		1.93	ns
t_{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		2.58		2.59		2.60	ns
t_{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t_{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

1.8 V LVCMOS

Low-Voltage Complementary Metal-Oxide Semiconductor for 1.8 V is an extension of the LVCMOS standard (JESD8-5) used for general-purpose 1.8 V applications. It uses a 3.3 V tolerant CMOS input buffer and a push-pull output buffer.

***Table 2-26* • DC Input and Output Levels**

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	**Max., V**	**Min., V**	**Max., V**	**Max., V**	**Min., V**	**mA**	**mA**
–0.3	0.2 VCCI	0.7 VCCI	3.6	0.2	VCCI – 0.2	8 mA	–8 mA

AC Loadings

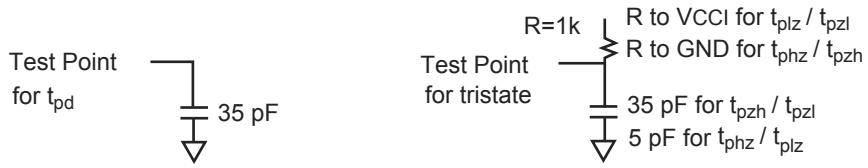


***Figure 2-17* • AC Test Loads**

***Table 2-27* • AC Waveforms, Measuring Points, and Capacitive Loads**

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C_{load} (pF)
0	1.8	0.5 VCCI	N/A	35

*Note: * Measuring Point = VTRIP*

***Table 2-40* • 3.3 V GTL+ I/O Module**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
3.3 V GTL+I/O Module Timing								
t_{DP}	Input Buffer		1.71		1.95		2.29	ns
t_{PY}	Output Buffer		1.13		1.29		1.52	ns
t_{ICLKQ}	Clock-to-Q for the I/O input register		0.67		0.77		0.90	ns
t_{OCLKQ}	Clock-to-Q for the I/O output register and the I/O enable register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

SSTL3

Stub Series Terminated Logic for 3.3 V is a general-purpose 3.3 V memory bus standard (JESD8-8). The Axcelerator devices support both classes of this standard. This requires a differential amplifier input buffer and a push-pull output buffer.

Class I

***Table 2-50* • DC Input and Output Levels**

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	**Max., V**	**Min., V**	**Max., V**	**Max., V**	**Min., V**	**mA**	**mA**
-0.3	VREF – 0.2	VREF +0.2	3.6	VREF – 0.6	VREF + 0.6	8	–8

AC Loadings

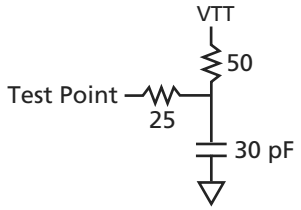


***Figure 2-23* • AC Test Loads**

***Table 2-51* • AC Waveforms, Measuring Points, and Capacitive Loads**

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C_{load} (pF)
VREF – 1.0	VREF + 1.0	VREF	1.50	30

*Note: *Measuring Point = VTRIP*

Timing Characteristics

***Table 2-52* • 3.3 V SSTL3 Class I I/O Module**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
3.3 V SSTL3 Class I I/O Module Timing								
t_{DP}	Input Buffer		1.78		2.03		2.39	ns
t_{PY}	Output Buffer		2.17		2.47		2.91	ns
t_{ICLKQ}	Clock-to-Q for the I/O input register		0.67		0.77		0.90	ns
t_{OCLKQ}	Clock-to-Q for the I/O output register and the I/O enable register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Vertical and Horizontal Routing

Vertical and Horizontal Tracks provide both local and long distance routing (Figure 2-37 on page 2-62). These tracks are composed of both short-distance, segmented routing and across-chip routing tracks (segmented at core tile boundaries). The short-distance, segmented routing resources can be concatenated through antifuse connections to build longer routing tracks.

These short-distance routing tracks can be used within and between SuperClusters or between modules of non-adjacent SuperClusters. They can be connected to the Output Tracks and to any logic module input (R-cell, C-cell, Buffer, and TX module).

The across-chip horizontal and vertical routing provides long-distance routing resources. These resources interface with the rest of the routing structures through the RX and TX modules (Figure 2-37). The RX module is used to drive signals from the across-chip horizontal and vertical routing to the Output Tracks within the SuperCluster. The TX module is used to drive vertical and horizontal across-chip routing from either short-distance horizontal tracks or from Output Tracks. The TX module can also be used to drive signals from vertical across-chip tracks to horizontal across-chip tracks and vice versa.

Figure 2-36 • **FastConnect Routing**

Figure 2-37 • **Horizontal and Vertical Tracks**

Note that the RAM blocks employ little-endian byte order for read and write operations.

***Table 2-88* • RAM Signal Description**

Signal	Direction	Description
WCLK	Input	Write clock (can be active on either edge).
WA[J:0]	Input	Write address bus.The value J is dependent on the RAM configuration and the number of cascaded memory blocks. The valid range for J is from 6 to15.
WD[M-1:0]	Input	Write data bus. The value M is dependent on the RAM configuration and can be 1, 2, 4, 9, 18, or 36.
RCLK	Input	Read clock (can be active on either edge).
RA[K:0]	Input	Read address bus. The value K is dependent on the RAM configuration and the number of cascaded memory blocks. The valid range for K is from 6 to 15.
RD[N-1:0]	Output	Read data bus. The value N is dependent on the RAM configuration and can be 1, 2, 4, 9, 18, or 36.
REN	Input	Read enable. When this signal is valid on the active edge of the clock, data at location RA will be driven onto RD.
WEN	Input	Write enable. When this signal is valid on the active edge of the clock, WD data will be written at location WA.
RW[2:0]	Input	Width of the read operation dataword.
WW[2:0]	Input	Width of the write operation dataword.
Pipe	Input	Sets the pipe option to be on or off.

Modes of Operation

There are two read modes and one write mode:

- Read Nonpipelined (synchronous – one clock edge)
- Read Pipelined (synchronous – two clock edges)
- Write (synchronous – one clock edge)

In the standard read mode, new data is driven onto the RD bus in the clock cycle immediately following RA and REN valid. The read address is registered on the read-port active-clock edge and data appears at read-data after the RAM access time. Setting the PIPE to OFF enables this mode.

The pipelined mode incurs an additional clock delay from address to data, but enables operation at a much higher frequency. The read-address is registered on the read-port active-clock edge, and the read data is registered and appears at RD after the second read clock edge. Setting the PIPE to ON enables this mode.

On the write active-clock edge, the write data are written into the SRAM at the write address when WEN is high. The setup time of the write address, write enables, and write data are minimal with respect to the write clock.

Write and read transfers are described with timing requirements beginning in the "Timing Characteristics" section on page 2-89.

BG729	
AX1000 Function	Pin Number
IO54PB1F5	E20
IO55NB1F5	E21
IO55PB1F5	D21
IO56NB1F5	H19
IO56PB1F5	G19
IO57NB1F5	D22
IO57PB1F5	C22
IO58NB1F5	B23
IO58PB1F5	A23
IO59NB1F5	D23
IO59PB1F5	C23
IO60NB1F5	G21
IO60PB1F5	G20
IO61NB1F5	E23
IO61PB1F5	E22
IO62NB1F5	F22
IO62PB1F5	F21
IO63NB1F5	H20
IO63PB1F5	J19
Bank 2	
IO64NB2F6	J21
IO64PB2F6	H21
IO65NB2F6	F24
IO65PB2F6	F23
IO66NB2F6	F26
IO66PB2F6	F25
IO67NB2F6	E26
IO67PB2F6	E25
IO68NB2F6	J22
IO68PB2F6	H22
IO69NB2F6	G24
IO69PB2F6	G23
IO70NB2F6	K20
IO70PB2F6	J20
IO71NB2F6	G26
IO71PB2F6	G25
IO72NB2F6	J24

BG729	
AX1000 Function	Pin Number
IO72PB2F6	J23
IO73NB2F6	H24
IO73PB2F6	H23
IO74NB2F7	L21
IO74PB2F7	K21
IO75NB2F7	G27
IO75PB2F7	F27
IO76NB2F7	K23
IO76PB2F7	K22
IO77NB2F7	H26
IO77PB2F7	H25
IO78NB2F7	K25
IO78PB2F7	K24
IO79NB2F7	J26
IO79PB2F7	J25
IO80NB2F7	M20
IO80PB2F7	L20
IO81NB2F7	J27
IO81PB2F7	H27
IO82NB2F7	L23
IO82PB2F7	L22
IO83NB2F7	L25
IO83PB2F7	L24
IO84NB2F7	N21
IO84PB2F7	M21
IO85NB2F8	K27
IO85PB2F8	K26
IO86NB2F8	M23
IO86PB2F8	M22
IO87NB2F8	M25
IO87PB2F8	M24
IO88NB2F8	L27
IO88PB2F8	L26
IO89NB2F8	M27
IO89PB2F8	M26
IO90NB2F8	N23
IO90PB2F8	N22

BG729	
AX1000 Function	Pin Number
IO91NB2F8	N25
IO91PB2F8	N24
IO92NB2F8	N27
IO92PB2F8	N26
IO93NB2F8	P26
IO93PB2F8	P27
IO94NB2F8	N19
IO94PB2F8	N20
IO95NB2F8	P23
IO95PB2F8	P22
Bank 3	
IO96NB3F9	P25
IO96PB3F9	P24
IO97NB3F9	R26
IO97PB3F9	R27
IO98NB3F9	P21
IO98PB3F9	P20
IO99NB3F9	R24
IO99PB3F9	R25
IO100NB3F9	T26
IO100PB3F9	T27
IO101NB3F9	T24
IO101PB3F9	T25
IO102NB3F9	R20
IO102PB3F9	R21
IO103NB3F9	R23
IO103PB3F9	R22
IO104NB3F9	U26
IO104PB3F9	U27
IO105NB3F9	U24
IO105PB3F9	U25
IO106NB3F9	R19
IO106PB3F9	P19
IO107NB3F10	V26
IO107PB3F10	V27
IO108NB3F10	T23
IO108PB3F10	T22

FG676	
AX500 Function	Pin Number
Bank 0	
IO00NB0F0	F8
IO00PB0F0	E8
IO01NB0F0	A5
IO01PB0F0	A4
IO02NB0F0	E7
IO02PB0F0	E6
IO03NB0F0	D6
IO03PB0F0	D5
IO04NB0F0	B5
IO04PB0F0	C5
IO05NB0F0	B6
IO05PB0F0	C6
IO06NB0F0	C7
IO06PB0F0	D7
IO07NB0F0	A7
IO07PB0F0	A6
IO08NB0F0	C8
IO08PB0F0	D8
IO09NB0F0	F10
IO09PB0F0	F9
IO10NB0F0	B8
IO10PB0F0	B7
IO11NB0F0	D10
IO11PB0F0	E10
IO12NB0F1	B9
IO12PB0F1	C9
IO13NB0F1	F11
IO13PB0F1	G11
IO14NB0F1	D11
IO14PB0F1	E11
IO15NB0F1	B10
IO15PB0F1	C10
IO16NB0F1	A10
IO16PB0F1	A9

FG676	
AX500 Function	Pin Number
IO17NB0F1	F12
IO17PB0F1	G12
IO18NB0F1	C12
IO18PB0F1	C11
IO19NB0F1/HCLKAN	A12
IO19PB0F1/HCLKAP	B12
IO20NB0F1/HCLKBN	C13
IO20PB0F1/HCLKBP	B13
Bank 1	
IO21NB1F2/HCLKCN	C15
IO21PB1F2/HCLKCP	C14
IO22NB1F2/HCLKDN	A15
IO22PB1F2/HCLKDP	B15
IO23NB1F2	F15
IO23PB1F2	G15
IO24NB1F2	B16
IO24PB1F2	A16
IO25NB1F2	A18
IO25PB1F2	A17
IO26NB1F2	D16
IO26PB1F2	E16
IO27NB1F2	F16
IO27PB1F2	G16
IO28NB1F2	C18
IO28PB1F2	C17
IO29NB1F2	B19
IO29PB1F2	B18
IO30NB1F2	D19
IO30PB1F2	C19
IO31NB1F2	F17
IO31PB1F2	E17
IO32NB1F3	B20
IO32PB1F3	A20
IO33NB1F3	B22
IO33PB1F3	B21

FG676	
AX500 Function	Pin Number
IO34NB1F3	D20
IO34PB1F3	C20
IO35NB1F3	D21
IO35PB1F3	C21
IO36NB1F3	D22
IO36PB1F3	C22
IO37NB1F3	F19
IO37PB1F3	E19
IO38NB1F3	B23
IO38PB1F3	A23
IO39NB1F3	E21
IO39PB1F3	E20
IO40NB1F3	D23
IO40PB1F3	C23
IO41NB1F3	D25
IO41PB1F3	C25
Bank 2	
IO42NB2F4	G24
IO42PB2F4	G23
IO43NB2F4	G26
IO43PB2F4	F26
IO44NB2F4	F25
IO44PB2F4	E25
IO45NB2F4	J21
IO45PB2F4	J22
IO46NB2F4	H25
IO46PB2F4	G25
IO47NB2F4	K23
IO47PB2F4	J23
IO48NB2F4	J24
IO48PB2F4	H24
IO49NB2F4	K21
IO49PB2F4	K22
IO50NB2F4	K25
IO50PB2F4	J25

FG676	
AX1000 Function	**Pin Number**
IO67PB2F6	E23
IO68NB2F6	H23
IO68PB2F6	H22
IO69NB2F6	D25
IO69PB2F6	C25
IO70NB2F6	G24
IO70PB2F6	G23
IO71NB2F6	F25
IO71PB2F6	E25
IO72NB2F6	G26
IO72PB2F6	F26
IO73NB2F6	E26
IO73PB2F6	D26
IO74NB2F7	J21
IO74PB2F7	J22
IO75NB2F7	J24
IO75PB2F7	H24
IO76NB2F7	K23
IO76PB2F7	J23
IO77NB2F7	H25
IO77PB2F7	G25
IO78NB2F7	K25
IO78PB2F7	J25
IO80NB2F7	K21
IO80PB2F7	K22
IO81NB2F7	K26
IO81PB2F7	J26
IO82NB2F7	L24
IO82PB2F7	K24
IO83NB2F7	L23
IO83PB2F7	L22
IO84NB2F7	L20
IO84PB2F7	L21
IO86NB2F8	L26
IO86PB2F8	L25
IO88NB2F8	M23

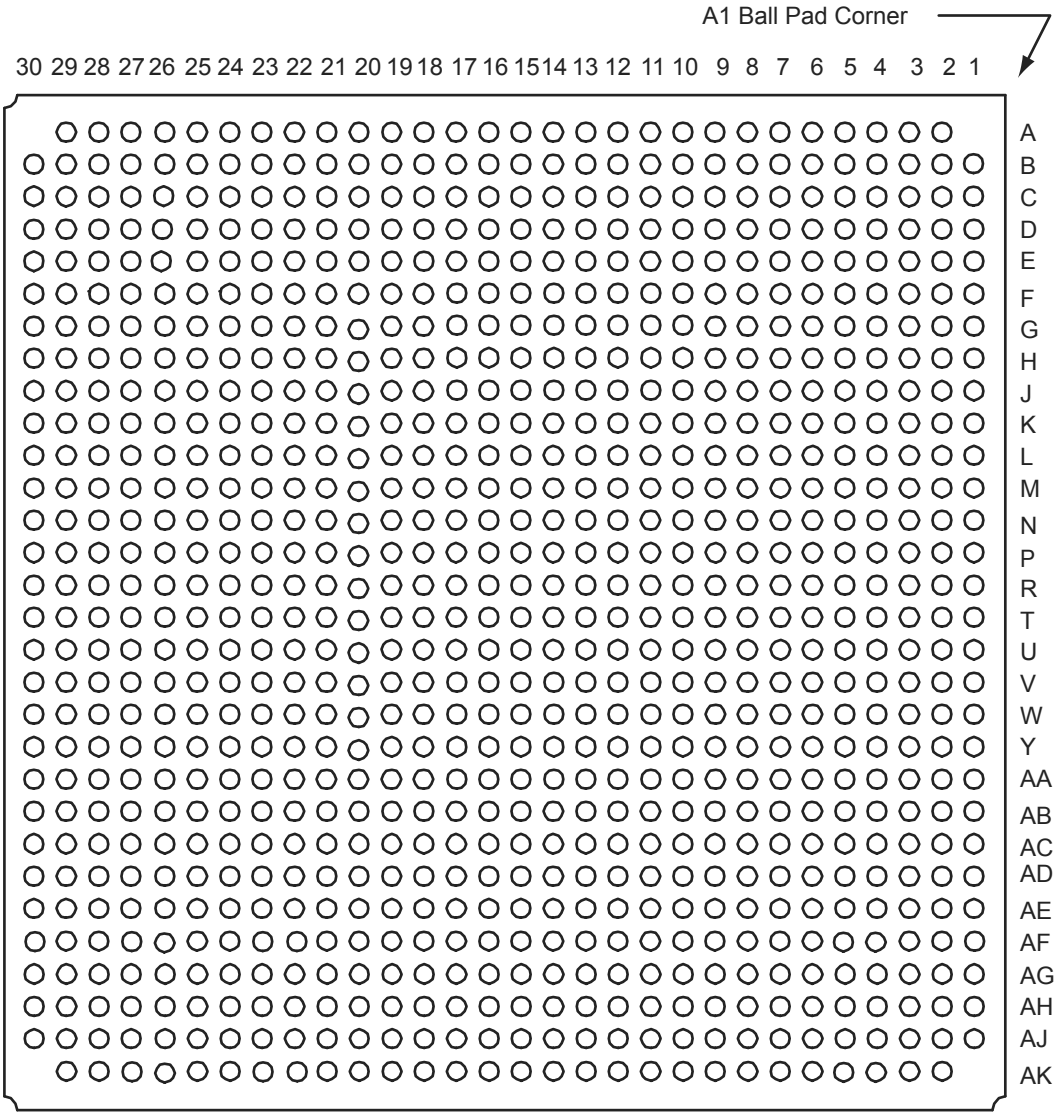
FG676	
AX1000 Function	**Pin Number**
IO88PB2F8	M22
IO89NB2F8	M26
IO89PB2F8	M25
IO90NB2F8	M20
IO90PB2F8	M21
IO91NB2F8	N24
IO91PB2F8	M24
IO92NB2F8	N22
IO92PB2F8	N23
IO94NB2F8	N20
IO94PB2F8	N21
IO95NB2F8	P25
IO95PB2F8	N25
Bank 3	
IO98NB3F9	P20
IO98PB3F9	P21
IO99NB3F9	R24
IO99PB3F9	P24
IO100NB3F9	R22
IO100PB3F9	P22
IO101NB3F9	T26
IO101PB3F9	R26
IO102NB3F9	R21
IO102PB3F9	R20
IO103NB3F9	T25
IO103PB3F9	R25
IO105NB3F9	V26
IO105PB3F9	U26
IO106NB3F9	T23
IO106PB3F9	R23
IO107NB3F10	U24
IO107PB3F10	T24
IO108NB3F10	U22
IO108PB3F10	T22
IO109NB3F10	V25
IO109PB3F10	U25

FG676	
AX1000 Function	**Pin Number**
IO110NB3F10	T21
IO110PB3F10	T20
IO112NB3F10	V23
IO112PB3F10	U23
IO113NB3F10	Y25
IO113PB3F10	W25
IO114NB3F10	V21
IO114PB3F10	U21
IO115NB3F10	W24
IO115PB3F10	V24
IO116NB3F10	AA26
IO116PB3F10	Y26
IO118NB3F11	AC26
IO118PB3F11	AB26
IO119NB3F11	AB25
IO119PB3F11	AA25
IO120NB3F11	W22
IO120PB3F11	V22
IO121NB3F11	Y23
IO121PB3F11	W23
IO122NB3F11	AA24
IO122PB3F11	Y24
IO123NB3F11	AE26
IO123PB3F11	AD26
IO124NB3F11	Y21
IO124PB3F11	W21
IO125NB3F11	AD25
IO125PB3F11	AC25
IO126NB3F11	AB23
IO126PB3F11	AA23
IO127NB3F11	AC24
IO127PB3F11	AB24
IO128NB3F11	AA22
IO128PB3F11	Y22
Bank 4	
IO129NB4F12	AB21

FG676	
AX1000 Function	**Pin Number**
VCCIB4	W18
VCCIB4	Y17
VCCIB4	Y18
VCCIB4	Y19
VCCIB5	W10
VCCIB5	W11
VCCIB5	W12
VCCIB5	W13
VCCIB5	W9
VCCIB5	Y10
VCCIB5	Y8
VCCIB5	Y9
VCCIB6	P8
VCCIB6	R8
VCCIB6	T8
VCCIB6	U7
VCCIB6	U8
VCCIB6	V7
VCCIB6	V8
VCCIB6	W7
VCCIB7	H7
VCCIB7	J7
VCCIB7	J8
VCCIB7	K7
VCCIB7	K8
VCCIB7	L8
VCCIB7	M8
VCCIB7	N8
VCOMPLA	D12
VCOMPLB	G13
VCOMPLC	D15
VCOMPLD	F14
VCOMPLE	AD15
VCOMPLF	AB14
VCOMPLG	AD12

FG676	
AX1000 Function	**Pin Number**
VCOMPLH	Y13
VPUMP	E22

FG896



Note

For Package Manufacturing and Environmental information, visit Resource center at http://www.microsemi.com/soc/products/rescenter/package/index.html.

FG896	
AX1000 Function	Pin Number
Bank 0	
IO00NB0F0	D6
IO00PB0F0	E6
IO01NB0F0	A5
IO01PB0F0	B5
IO02NB0F0	G9
IO02PB0F0	G8
IO03NB0F0	F8
IO03PB0F0	F7
IO04NB0F0	D7
IO04PB0F0	E7
IO05NB0F0	C7
IO05PB0F0	C6
IO06NB0F0	H9
IO06PB0F0	H8
IO07NB0F0	D8
IO07PB0F0	E8
IO08NB0F0	E9
IO08PB0F0	F9
IO09NB0F0	A7
IO09PB0F0	B7
IO10NB0F0	H10
IO10PB0F0	G10
IO11NB0F0	C9
IO11PB0F0	C8
IO12NB0F1	E10
IO12PB0F1	F10
IO13NB0F1	D10
IO13PB0F1	D9
IO14NB0F1	F11
IO14PB0F1	G11
IO15NB0F1	A10
IO15PB0F1	A9
IO16NB0F1	H12
IO16PB0F1	H11

FG896	
AX1000 Function	Pin Number
IO17NB0F1	B11
IO17PB0F1	B10
IO18NB0F1	D11
IO18PB0F1	E11
IO19NB0F1	C12
IO19PB0F1	C11
IO20NB0F1	F12
IO20PB0F1	G12
IO21NB0F1	D12
IO21PB0F1	E12
IO22NB0F2	H13
IO22PB0F2	J13
IO23NB0F2	A12
IO23PB0F2	A11
IO24NB0F2	F13
IO24PB0F2	G13
IO25NB0F2	B13
IO25PB0F2	B12
IO26NB0F2	E14
IO26PB0F2	E13
IO27NB0F2	B14
IO27PB0F2	A14
IO28NB0F2	H14
IO28PB0F2	J14
IO29NB0F2	B15
IO29PB0F2	A15
IO30NB0F2/HCLKAN	C14
IO30PB0F2/HCLKAP	D14
IO31NB0F2/HCLKBN	E15
IO31PB0F2/HCLKBP	D15
Bank 1	
IO32NB1F3/HCLKCN	E17
IO32PB1F3/HCLKCP	E16
IO33NB1F3/HCLKDN	C17
IO33PB1F3/HCLKDP	D17

FG896	
AX1000 Function	Pin Number
IO34NB1F3	A17
IO34PB1F3	B17
IO35NB1F3	D18
IO35PB1F3	C18
IO36NB1F3	H17
IO36PB1F3	J17
IO37NB1F3	B19
IO37PB1F3	A19
IO38NB1F3	H18
IO38PB1F3	J18
IO39NB1F3	B20
IO39PB1F3	A20
IO40NB1F3	C20
IO40PB1F3	C19
IO41NB1F4	E20
IO41PB1F4	E19
IO42NB1F4	F18
IO42PB1F4	G18
IO43NB1F4	A22
IO43PB1F4	A21
IO44NB1F4	F20
IO44PB1F4	F19
IO45NB1F4	D21
IO45PB1F4	D20
IO46NB1F4	D22
IO46PB1F4	C22
IO47NB1F4	A25
IO47PB1F4	A24
IO48NB1F4	H19
IO48PB1F4	G19
IO49NB1F4	C24
IO49PB1F4	C23
IO50NB1F4	G20
IO50PB1F4	H20
IO51NB1F4	F21

CQ208	
AX500 Function	Pin Number
IO150PB7F14	19
IO152NB7F14	16
IO152PB7F14	17
IO161NB7F15	12
IO161PB7F15	13
IO163NB7F15	10
IO163PB7F15	11
IO165PB7F15	7
IO166NB7F15	5
IO166PB7F15	6
IO167NB7F15	3
IO167PB7F15	4
Dedicated I/O	
VCCDA	1
GND	9
GND	15
GND	21
GND	32
GND	39
GND	46
GND	51
GND	59
GND	65
GND	69
GND	90
GND	94
GND	99
GND	104
GND	113
GND	119
GND	125
GND	136
GND	143
GND	150
GND	155
GND	164
GND	169

CQ208	
AX500 Function	Pin Number
GND	173
GND	194
GND	196
GND	201
GND/LP	208
PRA	184
PRB	183
PRC	80
PRD	79
TCK	205
TDI	204
TDO	203
TMS	206
TRST	207
VCCA	2
VCCA	14
VCCA	38
VCCA	52
VCCA	64
VCCA	93
VCCA	118
VCCA	142
VCCA	156
VCCA	168
VCCA	195
VCCDA	26
VCCDA	53
VCCDA	63
VCCDA	78
VCCDA	95
VCCDA	105
VCCDA	130
VCCDA	157
VCCDA	167
VCCDA	182
VCCDA	202
VCCIB0	193

CQ208	
AX500 Function	Pin Number
VCCIB0	200
VCCIB1	163
VCCIB1	172
VCCIB2	135
VCCIB2	149
VCCIB3	112
VCCIB3	124
VCCIB4	89
VCCIB4	98
VCCIB5	58
VCCIB5	68
VCCIB6	31
VCCIB6	45
VCCIB7	8
VCCIB7	20
VCCPLA	189
VCCPLB	187
VCCPLC	178
VCCPLD	176
VCCPLE	85
VCCPLF	83
VCCPLG	74
VCCPLH	72
VCOMPLA	190
VCOMPLB	188
VCOMPLC	179
VCOMPLD	177
VCOMPLE	86
VCOMPLF	84
VCOMPLG	75
VCOMPLH	73
VPUMP	158

CQ352	
AX1000 Function	Pin Number
Bank 0	
IO02NB0F0	341
IO02PB0F0	342
IO03PB0F0	343
IO04NB0F0	337
IO04PB0F0	338
IO08NB0F0	331
IO08PB0F0	332
IO09NB0F0	335
IO09PB0F0	336
IO24NB0F2	325
IO24PB0F2	326
IO25NB0F2	323
IO25PB0F2	324
IO30NB0F2/HCLKAN	319
IO30PB0F2/HCLKAP	320
IO31NB0F2/HCLKBN	313
IO31PB0F2/HCLKBP	314
Bank 1	
IO32NB1F3/HCLKCN	305
IO32PB1F3/HCLKCP	306
IO33NB1F3/HCLKDN	299
IO33PB1F3/HCLKDP	300
IO38NB1F3	295
IO38PB1F3	296
IO54NB1F5	287
IO54PB1F5	288
IO55NB1F5	289
IO55PB1F5	290
IO56NB1F5	281
IO56PB1F5	282
IO57NB1F5	283
IO57PB1F5	284
IO59NB1F5	277
IO59PB1F5	278

CQ352	
AX1000 Function	Pin Number
IO60NB1F5	275
IO60PB1F5	276
IO61NB1F5	271
IO61PB1F5	272
IO63NB1F5	269
IO63PB1F5	270
Bank 2	
IO64NB2F6	259
IO64PB2F6	260
IO67NB2F6	261
IO67PB2F6	262
IO68NB2F6	255
IO68PB2F6	256
IO69NB2F6	253
IO69PB2F6	254
IO74NB2F7	249
IO74PB2F7	250
IO75NB2F7	247
IO75PB2F7	248
IO76NB2F7	243
IO76PB2F7	244
IO77NB2F7	241
IO77PB2F7	242
IO78NB2F7	237
IO78PB2F7	238
IO79NB2F7	235
IO79PB2F7	236
IO82NB2F7	231
IO82PB2F7	232
IO83NB2F7	229
IO83PB2F7	230
IO94NB2F8	225
IO94PB2F8	226
IO95NB2F8	223
IO95PB2F8	224

CQ352	
AX1000 Function	Pin Number
Bank 3	
IO96NB3F9	217
IO96PB3F9	218
IO97NB3F9	219
IO97PB3F9	220
IO99NB3F9	213
IO99PB3F9	214
IO108NB3F10	211
IO108PB3F10	212
IO109NB3F10	207
IO109PB3F10	208
IO111NB3F10	205
IO111PB3F10	206
IO112NB3F10	199
IO112PB3F10	200
IO113NB3F10	201
IO113PB3F10	202
IO115NB3F10	195
IO115PB3F10	196
IO116NB3F10	193
IO116PB3F10	194
IO117NB3F10	189
IO117PB3F10	190
IO124NB3F11	183
IO124PB3F11	184
IO125NB3F11	187
IO125PB3F11	188
IO127NB3F11	181
IO127PB3F11	182
IO128NB3F11	179
IO128PB3F11	180
Bank 4	
IO130NB4F12	172
IO130PB4F12	173
IO131NB4F12	170

CG624	
AX2000 Function	**Pin Number**
VCCIB2	D23
VCCIB2	E22
VCCIB2	K17
VCCIB2	L17
VCCIB2	M16
VCCIB3	AA22
VCCIB3	AB23
VCCIB3	AC24
VCCIB3	AC25
VCCIB3	P16
VCCIB3	R17
VCCIB3	T17
VCCIB4	AB21
VCCIB4	AC22
VCCIB4	AD23
VCCIB4	AE23
VCCIB4	T14
VCCIB4	U15
VCCIB4	U16
VCCIB5	AB5
VCCIB5	AC4
VCCIB5	AD3
VCCIB5	AE3
VCCIB5	T12
VCCIB5	U10
VCCIB5	U11
VCCIB6	AA4
VCCIB6	AB3
VCCIB6	AC1
VCCIB6	AC2
VCCIB6	P10
VCCIB6	R9

*Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.*

CG624	
AX2000 Function	**Pin Number**
VCCIB6	T9
VCCIB7	C1
VCCIB7	C2
VCCIB7	D3
VCCIB7	E4
VCCIB7	K9
VCCIB7	L9
VCCIB7	M10
VCCPLA	E12
VCCPLB	J12
VCCPLC	E14
VCCPLD	H14
VCCPLE	Y14
VCCPLF	U14
VCCPLG	Y12
VCCPLH	U12
VCOMPLA	F12
VCOMPLB	H12
VCOMPLC	F14
VCOMPLD	J14
VCOMPLE	AA14
VCOMPLF	V14
VCOMPLG	AA12
VCOMPLH	V12
VPUMP	E20

*Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.*